

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74LCX07F, TC74LCX07FK

Low-Voltage HEX Buffer with 5-V Tolerant Inputs and Outputs (open drain)

The TC74LCX07 is a high-performance CMOS buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

The TC74LCX07 has high performance MOS N-channel transistor. (open-drain outputs)  $\,$ 

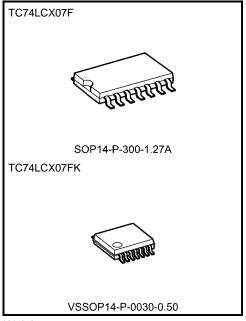
The device is designed for low-voltage (3.3 V) V<sub>CC</sub> applications, but it could be used to interface to 5-V supply\* environment for inputs.

All inputs are equipped with protection circuits against static discharge.

\*Iout absolute maximum rating must be observed.

#### **Features**

- Low-voltage operation: VCC = 1.65 to 5.5 V
- High-speed operation:  $t_{pz} = 3.7 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current:  $I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Available in JEITA SOP, VSSOP (US)
- Open-drain outputs
- · Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 07 type



Weight

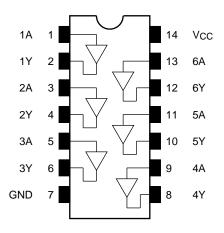
SOP14-P-300-1.27A : 0.18 g ( typ.) VSSOP14-P-0030-0.50 : 0.02 g ( typ.)

Note: The Electrical Characteristics of  $V_{CC}$  = 1.8 ± 0.15 V and that of  $V_{CC}$  = 5.0 ± 0.5 V are only applicable for products which manufactured from January 2009 onward.

Start of commercial production 1999-10



#### Pin Assignment (top view)



### **IEC Logic Symbol**

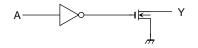
1 / _	1	1 0	2	1Y
1A -	3	<u> </u>	4	2Y
2A -	5		6	2 Y 3 Y
3A -	9		8	
4A -	11		10	4Y
5A -	13		12	5Y 6Y
OA				Οī

#### **Truth Table**

Inputs	Outputs
Α	Υ
L	L
Н	Z

Z: High impedance

### System Diagram (per gate)



#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vcc	-0.5 to 7.0	V
DC input voltage	VIN	-0.5 to 7.0	V
DC output voltage	Vout	-0.5 to 7.0 (Note 2)	V
Input diode current	lıK	-50	mA
Output diode current	lok	-50 (Note 3)	mA
DC output current	lout	50	mA
Power dissipation	PD	180	mW
DC V <sub>CC</sub> /ground current	ICC/IGND	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state. IOUT absolute maximum rating must be observed (Output in low state)

Note 3: Vout < GND



# **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit
Dower oupply voltage	Voc	1.65 to 5.5	V
Power supply voltage	Vcc	1.5 to 5.5 (Note 2)	V
Input voltage	VIN	0 to 5.5	V
Output voltage	Vout	0 to 5.5	V
		32 (Note 3)	
Output current	loL	24 (Note 4)	mA
		12 (Note 5)	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 6)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only Note 3: VCC = 4.5 to 5.5 V Note 4: VCC = 3.0 to 3.6 V Note 5: VCC = 2.7 to 3.0 V Note 6: VCC = 1.65 to 5.5 V



### **Electrical Characteristics**

# DC Characteristics (Ta = -40 to 85°C)

Characteristics		Symbol	Test Condition			Min	Max	Unit
Characteristics Symbol Te		Test Col	rest Condition		IVIII I	IVIAX	Offic	
						V <sub>CC</sub> × 0.9	_	
		.,				1.7	_	
	H-level	VIH	_	_	2.7 to 3.6	2.0		
					4.5 to 5.5	Vcc × 0.7		.,
Input voltage					1.65 to 2.3	_	V <sub>CC</sub> × 0.1	V
	I. Invest				2.3 to 2.7	_	0.7	-
	L-level	V <sub>IL</sub>	_	_	2.7 to 3.6	_	0.8	
						_	V <sub>CC</sub> × 0.3	
			VOL VIN = VIL II	I <sub>OL</sub> = 100 μA	1.65 to 5.5	_	0.2	
	L-level			I <sub>OL</sub> = 4 mA	1.65	_	0.45	V -
		VoL		I <sub>OL</sub> = 8 mA	2.3	_	0.7	
Output voltage				I <sub>OL</sub> = 12 mA	2.7	_	0.4	
				I <sub>OL</sub> = 16 mA	3.0	_	0.4	
				I <sub>OL</sub> = 24 mA	3.0	_	0.55	
				I <sub>OL</sub> = 32 mA	4.5	_	0.55	
Input leakage current	1	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		1.65 to 5.5	_	±5.0	μА
Output OFF state current		loz	VIN = VIH, VOUT = 0 to 5.5 V		1.65 to 5.5	_	±5.0	μА
Power-off leakage current		loff	V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0	_	10.0	μА
Quiescent supply current		Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		1.65 to 5.5	_	10.0	
					2.7 to 3.6	_	500	μΑ
Increase in I <sub>CC</sub> per inp	out	ΔICC	VIH = ACC - 0.9 A	$V_{IH} = V_{CC} - 0.6 V \text{ (per 1 input)}$		_	1	mA



### AC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
			1.8 ± 0.15	1.5	22.0	
			2.5 ± 0.2	1.2	11.0	
Output enable time	t <sub>pZL</sub>	Figure 1, Figure 2	2.7	1.0	4.4	ns
		$3.3\pm0.3$	0.8	3.7		
			5.0 ± 0.5	0.5	3.0	
	t <sub>pLZ</sub>	Figure 1, Figure 2	1.8 ± 0.15	1.5	22.0	ns
			$2.5\pm0.2$	1.2	11.0	
Output disable time			2.7	1.0	4.4	
			$3.3 \pm 0.3$	0.8	3.7	
			$5.0 \pm 0.5$	0.5	3.0	
Output to output skew	too7l	/NI=t=\	2.7	_	_	ns
Output to output skew	tosZL	(Note)	$3.3 \pm 0.3$		1.0	115

Note: Parameter guaranteed by design.

(tosZL = |tpZLm - tpZLn|)

### Dynamic Switching Characteristics (Ta = 25°C, input: tr = tf = 2.5 ns, CL = 50 pF, RL = 500 $\Omega$ )

Characteristics	Symbol	Test Condition	Vcc (V)	Тур.	Unit
Quiet output maximum dynamic V <sub>OL</sub>	VOLP	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic VOL	Volv	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	0.8	V

#### **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Vcc (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>		3.3	7	pF
Output capacitance	Cout	_	3.3	8	pF
Power dissipation capacitance	CPD	f <sub>IN</sub> = 10 MHz (Note	) 3.3	5	pF

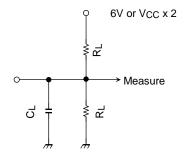
Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

ICC (opr) = CPD·VCC·fIN + ICC/6 (per gate)



### **AC Test Circuit**



Parameter	Switch		
	6.0 V	@ $V_{CC} = 3.3 \pm 0.3 \text{ V}$ @ $V_{CC} = 2.7 \text{ V}$	
<sup>t</sup> pLZ, <sup>t</sup> pZL	V <sub>CC</sub> × 2	@ $V_{CC} = 5.0 \pm 0.5 \text{ V}$ @ $V_{CC} = 2.5 \pm 0.2 \text{ V}$ @ $V_{CC} = 1.8 \pm 0.15 \text{ V}$	

Figure 1

### **AC Waveform**

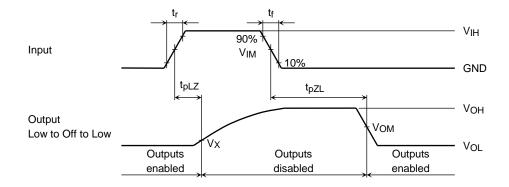


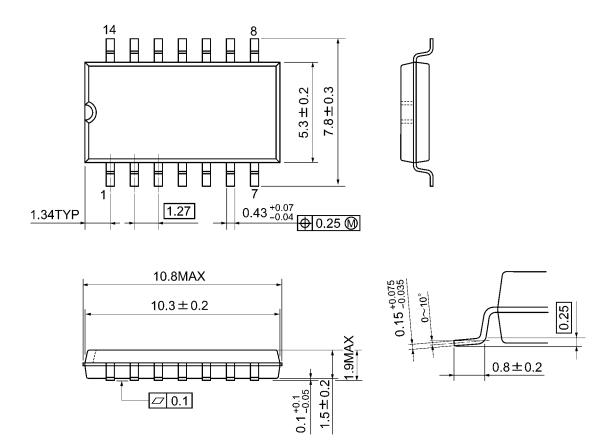
Figure 2  $t_{pLZ}$ ,  $t_{pZL}$ 

			V	CC	
	Symbol	5.0 ± 0.5 V	3.3 ± 0.3 V 2.7 V	2.5 ± 0.2 V	1.8 ± 0.15 V
Input	VIH	Vcc	2.7 V	Vcc	Vcc
	VIM	Vcc/2	1.5 V	Vcc/2	Vcc/2
	t <sub>r</sub> , t <sub>f</sub>	2.5 ns	2.5 ns	2.0 ns	2.0 ns
Output	V <sub>OM</sub>	V <sub>CC</sub> /2	1.5 V	V <sub>OH</sub> /2	V <sub>OH</sub> /2
	VX	V <sub>OL</sub> +0.3 V	V <sub>OL</sub> +0.3 V	V <sub>OL</sub> +0.15 V	V <sub>OL</sub> +0.15 V
Load	CL	50 pF	50 pF	30 pF	30 pF
	RL	500 Ω	500 Ω	500 Ω	1 kΩ



# **Package Dimensions**

SOP14-P-300-1.27A Unit: mm

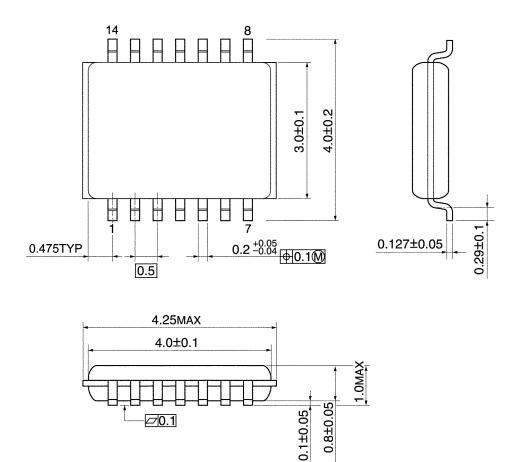


Weight: 0.18 g (typ.)



# **Package Dimensions**

VSSOP14-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)



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